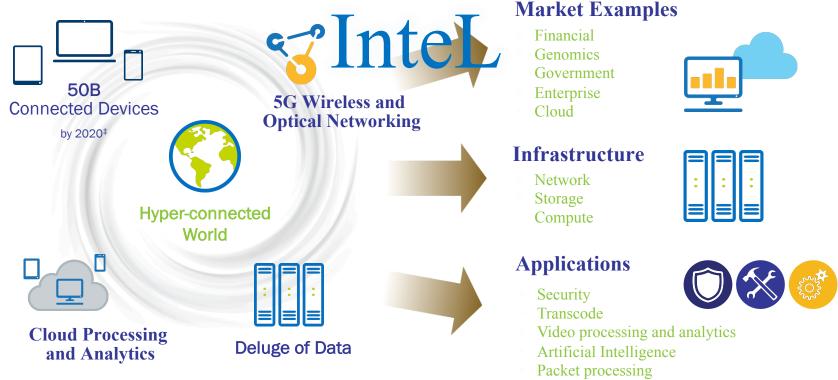


# Intel and OCP: Collaboration and Innovation

Mark Seager Intel Fellow, CTO for HPC Ecosystem Intel Corporation



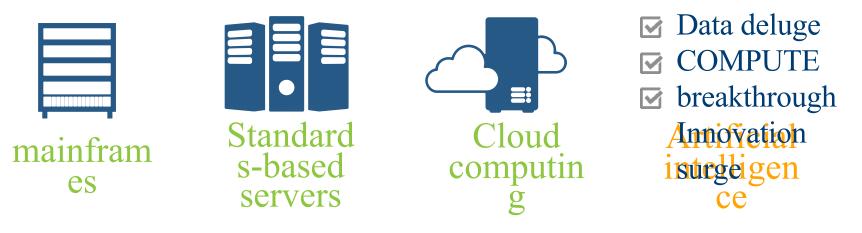
# DigitaL Transformation with



Open Solutions accelerating the pace of innovation



# AI: The next wave of computing



# AI Compute Cycles will grow by 2020





Intel Driving Innovation and Collaboration in Al

# Project Lightning





#### NVMe designed for OCP

- It scales
- It's open
- Flexible form factors
- Enables hot and warm storage



Source: https://code.facebook.com/posts/989638804458007/in troducing-lightning-a-flexible-nvme-jbof/



## Next Generation Intel® Xeon® Processor (Codename Skylake)

- Next-Generation Platform For Multi-Cloud Infrastructures
- HW-Enhancements for great performance, security, & efficiency
- ✓ Per core perf enhancements
   ✓ Intel® AVX-512 acceleration
   ✓ Accelerated IO with Intel® Omni-Path Architecture (fabric)
- ✓ Integrated Intel® Quick Assist Technology (crypto offload)
- ✓ Advanced RAS
- ✓ Intel® Resource Director Technology

#### Next generation of OCP designs based on Skylake and Intel World Wide Enabling Programs





## Microsoft\* Project Olympus

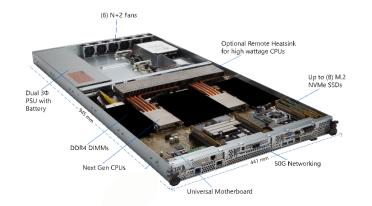
Next generation Universal Motherboard for Hyperscale Cloud

XEON: inside

- Based on next generation Intel® Xeon®
   processor, codename Skylake
  - Intel® AVX-512: Up to 2X FLOP/sec peak perf capability versus prior gen.<sup>1</sup>
  - Integrated Intel® Quick Assist Technology (crypto offload)
- Supports Intel® Arria 10® FPGAs to provide a configurable framework
- Intel FPGAs accelerate network, encryption, compression & DNN functions

**OPEN SOFTWARE.** 

**OPEN HARDWARE.** 



https://azure.microsoft.com/en-us/blog/microsoftreimagines-open-source-cloud-hardware/

#### Standardized platform for various workloads without compromising on performance

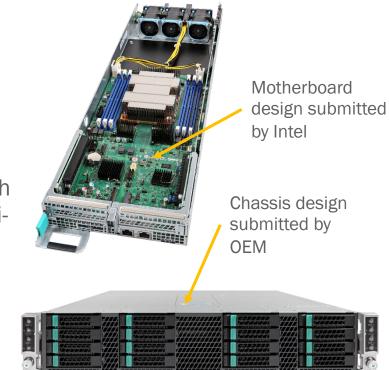
1 Refer to https://software.intel.com/en-us/blogs/2013/avx-512-instructions

\* Other names and brands are property of others.



#### Compute: Intel® Server Board S7200AP (Adams Pass)

- Specifically designed for highly parallelized workflows
- Support for Intel® Xeon® Phi<sup>™</sup> processors with 6 DIMMs and optional support for Intel® Omni-Path Fabric Technology
- Customizable as a 2U, four node system
- Submitted Adams Pass to the OCP Foundation
- Enabled Penguin chassis submitted to OCP foundation



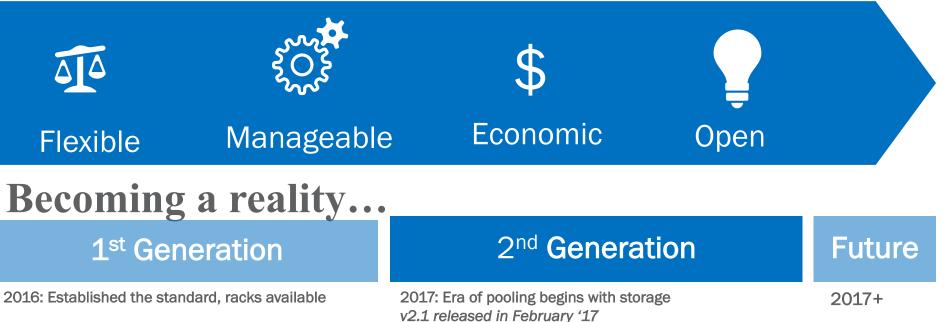


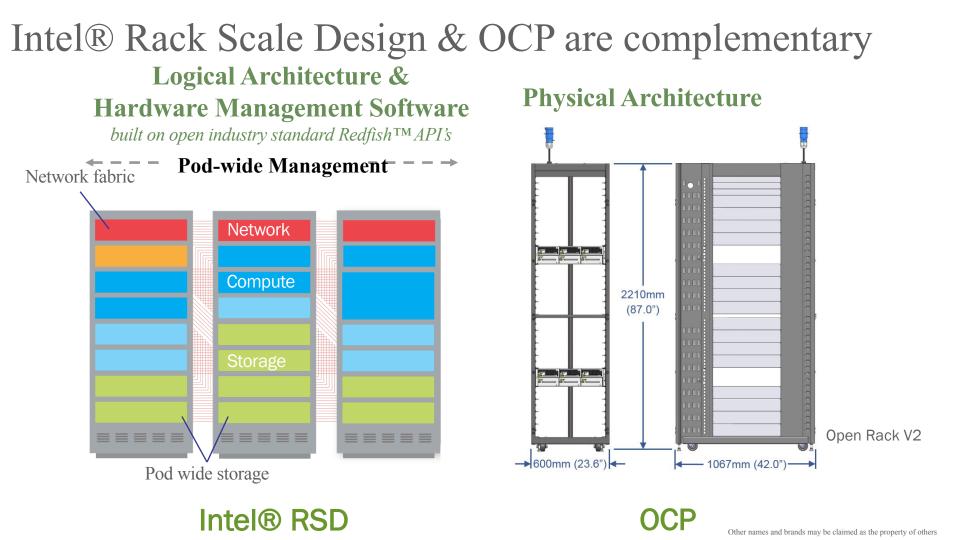


\*Other names and brands may be claimed as property of others

Intel® RSD - Revolutionizing the Datacenter Laying the foundation for the modern scalable data center

## Intel® RSD Vision:





# Datacenter Management SW

Intel heavily invested in open source

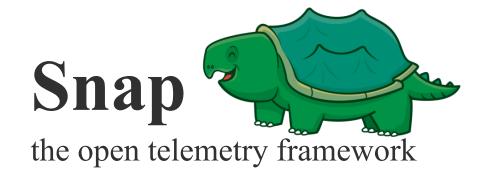
A Linux Foundation Community with 30 members

**OpenHPC** 

- tion 30 members de la construction de la constructi
- ✓ Over 60 Open Source components validated and integrated to ease High Performance Computing system installation, management and maintenance

http://openhpc.community



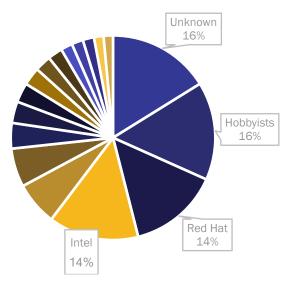


✓ Over 80 plugins w/ libraries for C++, Python, Go http://snap-telemetry.io

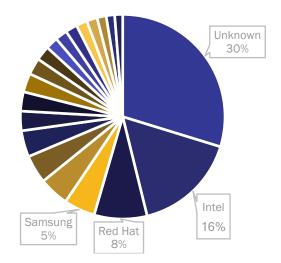


### Intel is a Major Linux Kernel Contributor

Contrib Since 2005



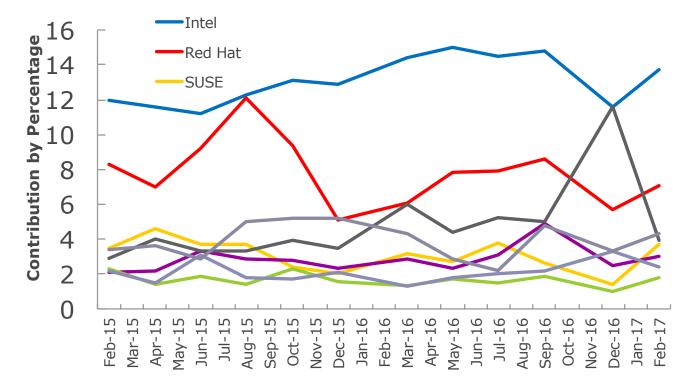
#4 Named contributor to Linux since 2005 OPEN HARDWARE. OPEN SOFTWARE. OPEN FUTURE. Contributations 4.10



#1 Named contributor to Linux 4.10



#### Intel #1 in Linux Kernel Contributions



OPEN HARDWARE. OPEN SOFTWARE. OPEN FUTURE.

Source: http://lwn.net



## Software Define Power® Innovations





Æ

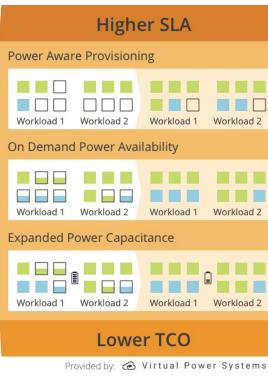
#### Peak Shaving

Utilize batteries to shave peaks and provide energy buffers for ride-throughs and multiple generations of growth

#### Dynamic Redundancy

Leverage unused redundant capacity for additional lower priority workloads

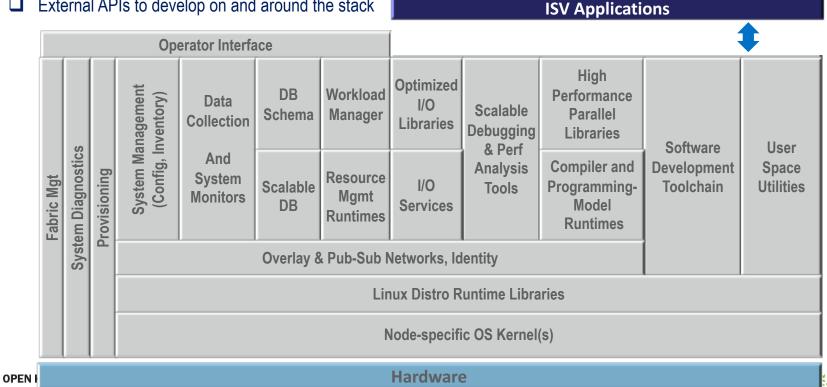
Workload Placement Optimize energy utilization by dynamic placement and scheduling of workloads





#### HPC Stack Component View Enables collaboration and innovation

- Intra-stack APIs to allow for customization/differentiation
- External APIs to develop on and around the stack



OPER Compute Projec

# enhoc OpenHPC Membership as of

OpenHPC is a Linux Foundation\* Project O Ve Calift and Rely 2vane hef initiated by Intel and gained wide participation right away

state of the software ecosystem

Governing board is composed of

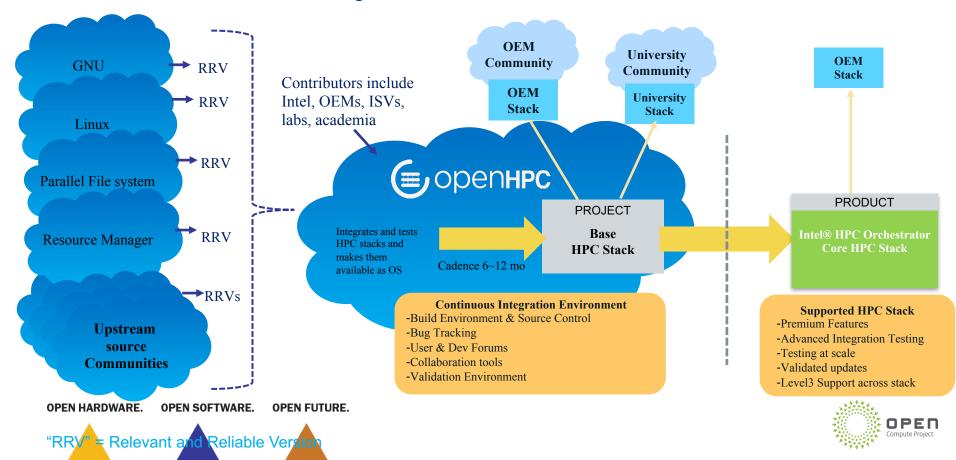
Academic, Technical committee

Platinum members, Silver &

**30 Members** 

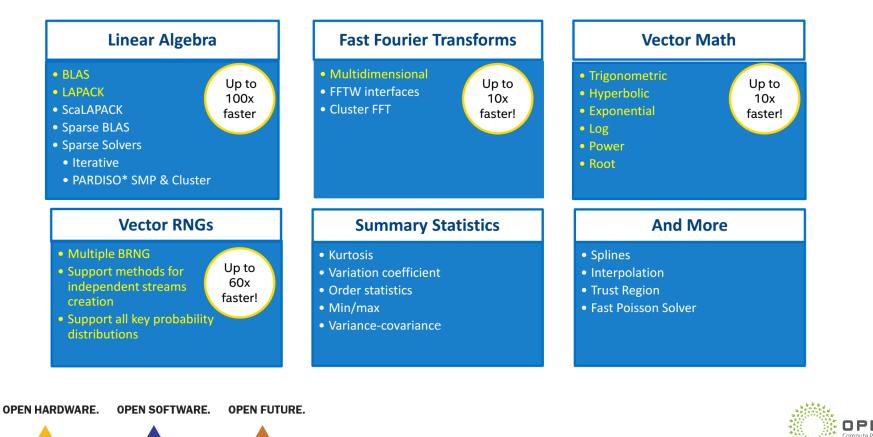
**Atos**  $\triangle$  Altair Barcelona **ARM**<sup>®</sup> BSC Supercomputing Center PSC **BERKELEY LAB** FUITSU **GENCI** Cea intel **Hewlett Packard** DØLL Korea Institute of Enterprise Science and Technology Information TACC Redhat. RRIKEN CINECA CLUSTER COMPETENCE PARTEC Los Alamos ۲Z CENTER Sandia Lawrence Livermore National Laboratory Lenovo National SUSE Argonne National Laboratory Center for Research in Extreme Scale Technologies -University of Cambridge Indiana University Courtesy of OpenHPC\* **OPEN SOFTWARE. OPEN FUTURE.** WWW.OpenHPC.Community \*Other names and brands may be claimed as the property of others.

#### Intel® HPC Orchestrator Framework: OSS Project and Product



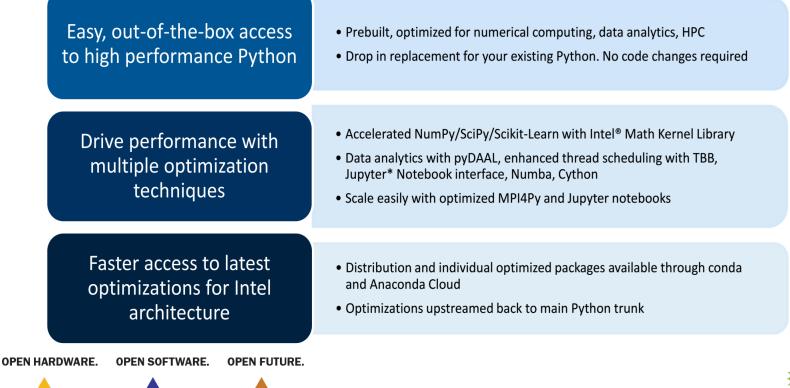
## NUMPY & SCIPY OPTIMIZATIONS WITH INTEL® MKL

Configuration info: - Versions: Intel® Distribution for Python 2017 Beta, icc 15.0; Hardware: Intel® Xeon® CPU E5-2698 v3 @ 2.30GHz (2 sockets, 16 cores each, HT=OFF), 64 GB of RAM, 8 DIMMS of 8GB@2133MHz; Operating System: Ubuntu 14.04 LTS.



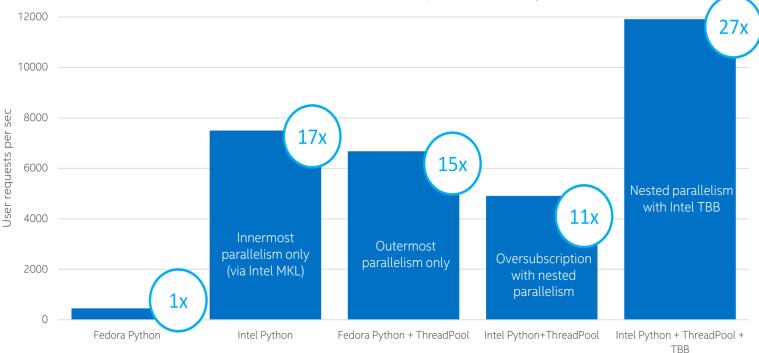
## **INTEL® DISTRIBUTION FOR PYTHON\* 2017**

#### Advancing Python performance closer to native speeds





#### Collaborative Filtering - Generation of User Recommendations Positive effect of TBB-based nested parallelism in Python



Configuration Info: - Versions: Intel(R) Distribution for Python 2.7.11 2017, Beta (Mar 04, 2016), MKL version 11.3.2 for Intel Distribution for Python 2017, Beta, Fedora\* built Python\*: Python 2.7.10 (default, Sep 8 2015), NumPy 1.9.2, SciPy 0.14.1, multiprocessing 0.70a1 built with gcc 5.1.1; Hardware: 96 CPUs (HT ON), 4 sockets (12 cores/socket), 1 NUMA node, Intel(R) Xeon(R) E5-4657L v2@2.40GHz, RAM 64GB, Operating System: Fedora release 23 (Twenty Three)



## **Legal Notices and Disclaimers**

- Intel technologies' features and benefits depend on system configuration and may require enabled hardware, software or service activation. Performance varies depending on system
  configuration. No computer system can be absolutely secure. Check with your system manufacturer or retailer or learn more at intel.com.
- Tests document performance of components on a particular test, in specific systems. Differences in hardware, software, or configuration will affect actual performance. Consult other sources
  of information to evaluate performance as you consider your purchase. For more complete information about performance and benchmark results, visit <a href="http://www.intel.com/performance">http://www.intel.com/performance</a>.
- Software and workloads used in performance tests may have been optimized for performance only on Intel microprocessors. Performance tests, such as SYSmark and MobileMark, are
  measured using specific computer systems, components, software, operations and functions. Any change to any of those factors may cause the results to vary. You should consult other
  information and performance tests to assist you in fully evaluating your contemplated purchases, including the performance of that product when combined with other products. For more
  complete information visit <a href="http://www.intel.com/performance">http://www.intel.com/performance</a>.
- Cost reduction scenarios described are intended as examples of how a given Intel-based product, in the specified circumstances and configurations, may affect future costs and provide cost savings. Circumstances will vary. Intel does not guarantee any costs or cost reduction.
- This document contains information on products, services and/or processes in development. All information provided here is subject to change without notice. Contact your Intel representative to obtain the latest forecast, schedule, specifications and roadmaps.
- No license (express or implied, by estoppel or otherwise) to any intellectual property rights is granted by this document.
- Statements in this document that refer to Intel's plans and expectations for the quarter, the year, and the future, are forward-looking statements that involve a number of risks and uncertainties. A detailed discussion of the factors that could affect Intel's results and plans is included in Intel's SEC filings, including the annual report on Form 10-K.
- All products, computer systems, dates and figures specified are preliminary based on current expectations, and are subject to change without notice. The products described may contain
  design defects or errors known as errata which may cause the product to deviate from published specifications. Current characterized errata are available on request.
- Intel does not control or audit third-party benchmark data or the web sites referenced in this document. You should visit the referenced web site and confirm whether referenced data are accurate.
- © 2017 Intel Corporation. Intel, the Intel logo [add word with ™ or <sup>®</sup> from the list of Intel's trademarks] and others are trademarks of Intel Corporation in the U.S. and/or other countries.
- \*Other names and brands may be claimed as the property of others.



